

08-03-2005

OMB No. 6514-0011(exp-4/94)

FN-US055139



103053903

To the Honorable Commissioner

Please record the attached original Documents or copy thereof.

1. Name of conveying party(ies):

(1) Kunio SAWAI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: **FUNAI ELECTRIC CO., LTD.**

Internal Address:

Street Address: **7-1, 7-chome, Nakagaito**City: **Daito**
Country: **JAPAN**Prefecture: **Osaka**
ZIP: **574-0013**Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: **(1) 07/25/05**

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: **(1) 07/25/05**

A. Patent Application No.(s)

B. Patent No.(s)

Additional Application numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name:

Shinju Global IP Counselors, LLP

Internal Address:

Street Address: **1233 Twentieth Street, NW**
Suite 700City: **Washington State: D.C.** ZIP: **20036**6. Total number of applications and patents involved: **1**7. Total fee (37 CFR 3.41) :..\$**40.00**☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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02 FEB 10 11

03 FEB 10 11

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Kiyoe K. Kabashima

Name of Person Signing

Signature

Date

July 27, 2005

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Total number of pages including cover sheet, attachments, and document:

2

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40.00 OP

Mail documents to be recorded with required cover sheet Information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

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FN-US055139

ASSIGNMENT

[Executed in Japan]

WHEREAS, Kunio SAWAI, a citizen of Japan residing at
c/o Funai Electric Co., Ltd. 7-1, 7-chome, Nakagaito, Daito, Osaka, 574-0013, Japan

hereinafter referred to as the Assignor(s), have invented certain new and useful improvements in

IMAGE FORMING APPARATUS

for which the Assignor(s) have executed an Application for United States Letters Patent

(X) Executed concurrently herewith

() Serial No. _____ Filed _____

AND WHEREAS, FUNAI ELECTRIC CO., LTD. having its principal place
of business at 7-1, 7-chome, Nakagaito, Daito, Osaka, 574-0013, Japan

(hereinafter referred to as the Assignee), is desirous of acquiring the entire right, title, and interest
in and to said invention and said Application and in and to any Letters Patent or Patents, United
States or foreign as indicated below, to be obtained therefor and thereon:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which
is herewith acknowledged, the Assignor(s) sell, assign, and transfer, unto the Assignee, its
successors, legal representatives and assigns, the entire right, title, and interest in the United States
of America, and in all foreign countries, in, to and under said improvements, and said
Application, and all original, divisional, renewal, continuation, substitute, or reissue applications
thereof, including the right to sue and recover for any past infringement, and all rights of priority
from the filing of said Application; and the Assignor(s) hereby authorize and request the
Commissioner of Patents and Trademarks to issue all Letters Patent on said improvements or
resulting therefrom to said Assignee herein, as assignee of the entire interest therein, for the sole
use and behalf of said Assignee, its successors, and assigns, to the full end of the term or terms
for which Letters Patent or Patents may be granted.

Further, the Assignor(s) and their legal representatives, heirs, and assigns do hereby agree and
covenant without further remuneration that they will communicate to said Assignee, its
successors, legal representatives and assigns, any facts known to them respecting said
improvements whenever requested, and will testify in any interferences or other legal proceeding
in which any of said applications or Letters Patent may become involved, sign all lawful papers,
execute and deliver all divisional, continuing, reissue and other applications for Letters Patent on
said improvements and all assignments thereof to said Assignee or its legal representatives,
successors, or assigns, make all rightful oaths and generally do everything necessary to assist
said Assignee, its successors, legal representatives and assigns, to obtain and enforce proper
patent protection for said improvements in the U.S. and said countries, the expenses incident to
said applications to be borne and paid by said assignee.

The undersigned hereby grants the firm of **Shinju Global IP Counselors, LLP** the power to insert in
this Assignment any further identification which may be necessary or desirable to comply with the
rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

IN TESTIMONY WHEREOF, the undersigned Assignor(s) have affixed their signatures.

This 25 day of July, 2005 Signature Kunio Sawai

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受信時刻 7月22日 23時01分

RECORDED: 07/27/2005

PATENT
REEL: 016823 FRAME: 0437